


PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCI No.	IPD/16/9652	
1.3 Title of PCI	Use of standard molding for VIPER53DIP-E and VIPER53EDIP-E at subcontractor Nantong Fujitsu Microelectronics Co. Ltd. (NFME)	
1.4 Product Category	HV Converter	
1.5 Issue date	2016-02-17	

2. PCI Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Francesca Marta SANDRINI
2.1.2 Marketing Manager	Maria Rosa BORGHI
2.1.3 Quality Manager	Paolo MORETTI

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Materials	Usage of an ST qualified direct material part number for a subcontracted assembly activity	Nantong Fujitsu Microelectronics Co. Ltd. (China)

4. Description of change

	Old	New
4.1 Description	The Commercial Products VIPER53DIP-E and VIPER53EDIP-E are manufactured in NFME with standard, non-green epoxy molding compound (MG46FAM) but wrongly defined as "green" on the labels.	The Commercial Products VIPER53DIP-E and VIPER53EDIP-E are manufactured in NFME with standard, non-green epoxy molding compound (MG46FAM) and correctly defined as "non-green" on the labels.
4.2 Anticipated Impact on form, fit, function, quality, reliability or processability?	No impact	

5. Reason / motivation for change

5.1 Motivation	Internal manufacturability rationalization for old generation Viper products.
5.2 Customer Benefit	SERVICE IMPROVEMENT

6. Marking of parts / traceability of change

6.1 Description	Eco-level on ST packaging labels
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7. Timing / schedule

7.1 Date of qualification results	2014-07-23
7.2 Intended start of delivery	2016-03-15
7.3 Qualification sample available?	Not Applicable

8. Qualification / Validation

8.1 Description	PCI_VIPER53_VIPER53E_STANDARD_MOLDING_NFME_rev2.pdf		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2016-02-17

9. Attachments (additional documentations)

9652PpPrdtLst.pdf
PCI_VIPER53_VIPER53E_STANDARD_MOLDING_NFME_rev2.pdf

10. Affected parts

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	VIPER53EDIP-E	



Public Products List

PCI Title : Use of standard molding for VIPER53DIP-E and VIPER53EDIP-E at subcontractor Nantong Fujitsu Microelectronics Co. Ltd. (NFME)

PCI Reference : IPD/16/9652

PCI Created on : 11-Feb-2016

Subject : Public Products List

Dear Customer,

Please find below the Standard Public Products List impacted by the change.

VIPER53DIP-E		
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